

TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

**TC74HC240AP,TC74HC240AF,TC74HC240AFW  
TC74HC241AP,TC74HC241AF  
TC74HC244AP,TC74HC244AF,TC74HC244AFW****Octal Bus Buffer**

TC74HC240AP/AF/AFW	Inverted, 3-State Outputs
TC74HC241AP/AF	Non-Inverted, 3-State Outputs
TC74HC244AP/AF/AFW	Non-Inverted, 3-State Outputs

The TC74HC240A, 241A and 244A are high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate C2MOS technology.

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC240A is an inverting 3-state buffer having two active-low output enables. The TC74HC241A and TC74HC244A are non-inverting 3-state buffers that differ only in that the 241A has one active-high and one active-low output enable, and the 244A has two active-low output enables.

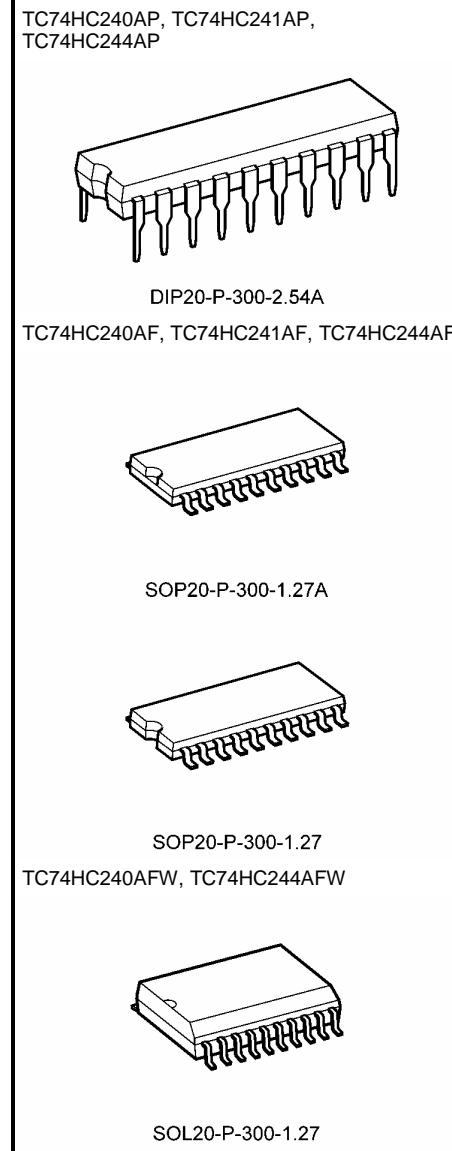
These devices are designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

**Features**

- High speed:  $t_{pd} = 10$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 4$   $\mu$ A (max) at  $T_a = 25^\circ C$
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\%$   $V_{CC}$  (min)
- Output drive capability: 15 LSTTL loads
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 6$  mA (min)
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2~6 V
- Pin and function compatible with 74LS240/241/244

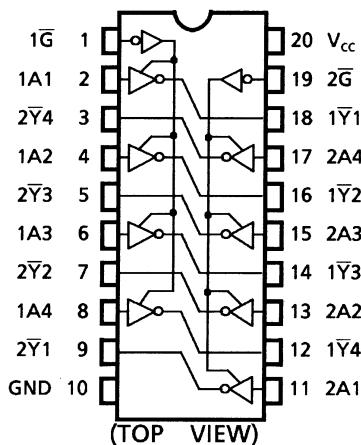
Note: xxxFW (JEDEC SOP) is not available in Japan.

**Weight**

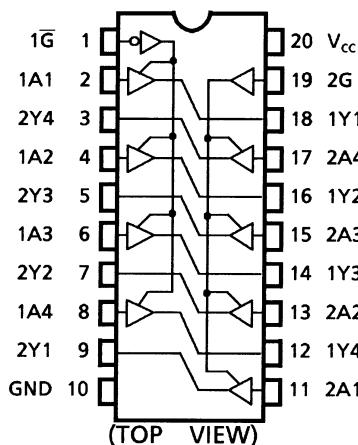
DIP20-P-300-2.54A	: 1.30 g (typ.)
SOP20-P-300-1.27A	: 0.22 g (typ.)
SOP20-P-300-1.27	: 0.22 g (typ.)
SOL20-P-300-1.27	: 0.46 g (typ.)

## Pin Assignment

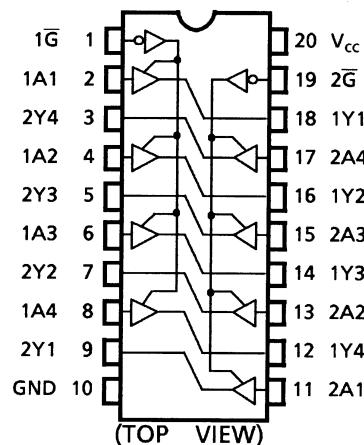
TC74HC240A



TC74HC241A

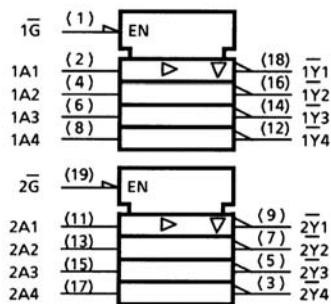


TC74HC244A

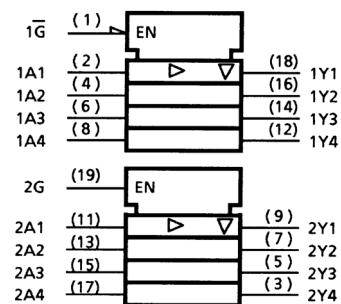


## IEC Logic Symbol

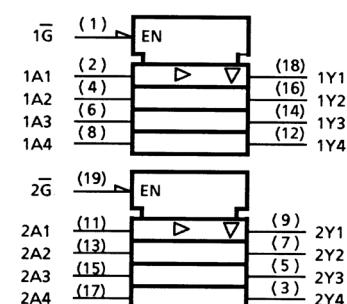
TC74HC240A



TC74HC241A



TC74HC244A



## Truth Table

Inputs			Outputs	
$\bar{G}$	$G^\Delta$	$A_n$	$Y_n$	$\bar{Y}_n^{\Delta\Delta}$
L	H	L	L	H
L	H	H	H	L
H	L	X	Z	Z

$\Delta$ : For TC74HC241A only

$\Delta\Delta$ : For TC74HC240A only

X: Don't care

Z: High impedance

**Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	−0.5~7	V
DC input voltage	$V_{IN}$	−0.5~ $V_{CC}$ + 0.5	V
DC output voltage	$V_{OUT}$	−0.5~ $V_{CC}$ + 0.5	V
Input diode current	$I_{IK}$	±20	mA
Output diode current	$I_{OK}$	±20	mA
DC output current	$I_{OUT}$	±35	mA
DC $V_{CC}$ /ground current	$I_{CC}$	±75	mA
Power dissipation	$P_D$	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	$T_{stg}$	−65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Note 2: 500 mW in the range of  $T_a$  = −40 to 65°C. From  $T_a$  = 65 to 85°C a derating factor of −10 mW/°C shall be applied until 300 mW.

**Recommended Operating Conditions (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2~6	V
Input voltage	$V_{IN}$	0~ $V_{CC}$	V
Output voltage	$V_{OUT}$	0~ $V_{CC}$	V
Operating temperature	$T_{opr}$	−40~85	°C
Input rise and fall time	$t_r, t_f$	0~1000 ( $V_{CC}$ = 2.0 V) 0~500 ( $V_{CC}$ = 4.5 V) 0~400 ( $V_{CC}$ = 6.0 V)	ns

Note: The recommended operating conditions are required to ensure the normal operation of the device.  
Unused inputs must be tied to either  $V_{CC}$  or GND.

## Electrical Characteristics

## DC Characteristics

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Ta = 25°C			Ta = -40~85°C		Unit
			Min	Typ.	Max	Min	Max		
High-level input voltage	V <sub>IH</sub>	—	2.0	1.50	—	—	1.50	—	V
			4.5	3.15	—	—	3.15	—	
			6.0	4.20	—	—	4.20	—	
Low-level input voltage	V <sub>IL</sub>	—	2.0	—	—	0.50	—	0.50	V
			4.5	—	—	1.35	—	1.35	
			6.0	—	—	1.80	—	1.80	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	—	1.9	V
			I <sub>OH</sub> = -6 mA	4.5	4.4	4.5	—	4.4	
			I <sub>OH</sub> = -7.8 mA	6.0	5.9	6.0	—	5.9	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 20 μA	2.0	—	0.0	0.1	—	V
			I <sub>OL</sub> = 6 mA	4.5	—	0.0	0.1	—	
			I <sub>OL</sub> = 7.8 mA	6.0	—	0.17	0.26	—	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND	6.0	—	—	±0.5	—	±5.0	μA
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	6.0	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	6.0	—	—	4.0	—	40.0	μA

AC Characteristics (input:  $t_r = t_f = 6$  ns)

Characteristics	Symbol	—	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
			CL (pF)	V <sub>CC</sub> (V)	Min	Typ.	Max	Min	Max		
Output transition time	$t_{TLH}$ $t_{THL}$	—	50	2.0	—	25	60	—	75	ns	
				4.5	—	7	12	—	15		
				6.0	—	6	10	—	13		
Propagation delay time	$t_{pLH}$	—	50	2.0	—	36	90	—	115	ns	
				4.5	—	12	18	—	23		
				6.0	—	10	15	—	20		
	$t_{pHL}$		150	2.0	—	51	130	—	165		
				4.5	—	17	26	—	33		
				6.0	—	14	22	—	28		
Output enable time	$t_{pZL}$	$R_L = 1\text{ k}\Omega$	50	2.0	—	48	125	—	155	ns	
				4.5	—	16	25	—	31		
				6.0	—	14	21	—	26		
	$t_{pZH}$		150	2.0	—	63	165	—	205		
				4.5	—	21	33	—	41		
				6.0	—	18	28	—	35		
Output disable time	$t_{pLZ}$ $t_{pHZ}$	$R_L = 1\text{ k}\Omega$	50	2.0	—	32	125	—	155	ns	
Input capacitance	$C_{IN}$	—	—	—	5	10	—	10	pF		
Output capacitance	$C_{OUT}$	—	—	—	10	—	—	—	pF		
Power dissipation capacitance	$C_{PD}$ (Note)	TC74HC240A			—	31	—	—	—	pF	
		TC74HC241A/244A			—	33	—	—	—		

Note:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

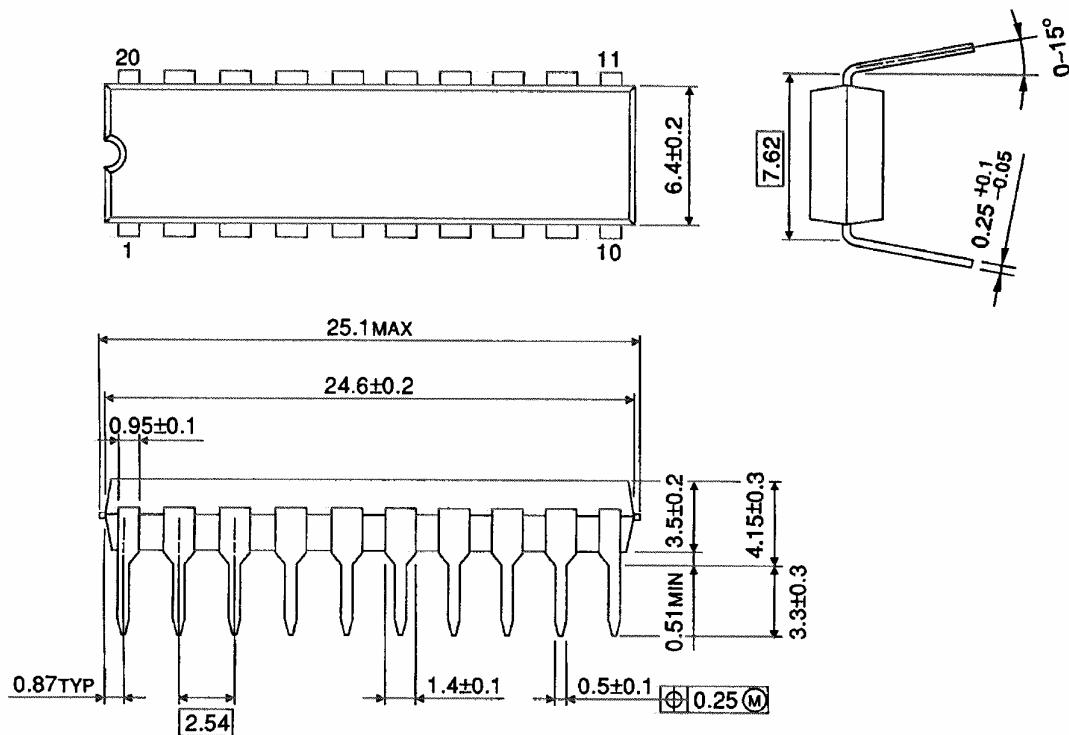
Average operating current can be obtained by the equation:

$$I_{CC}(\text{opr}) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$$

**Package Dimensions**

DIP20-P-300-2.54A

Unit : mm

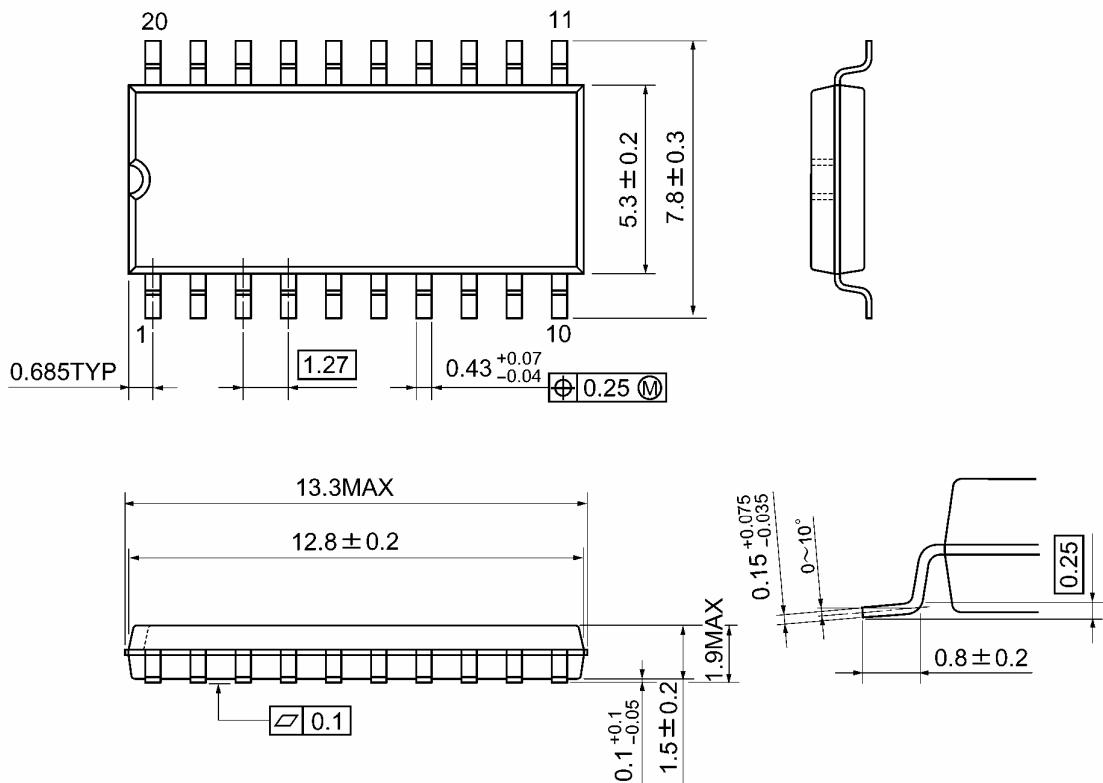


Weight: 1.30 g (typ.)

**Package Dimensions**

SOP20-P-300-1.27A

Unit: mm

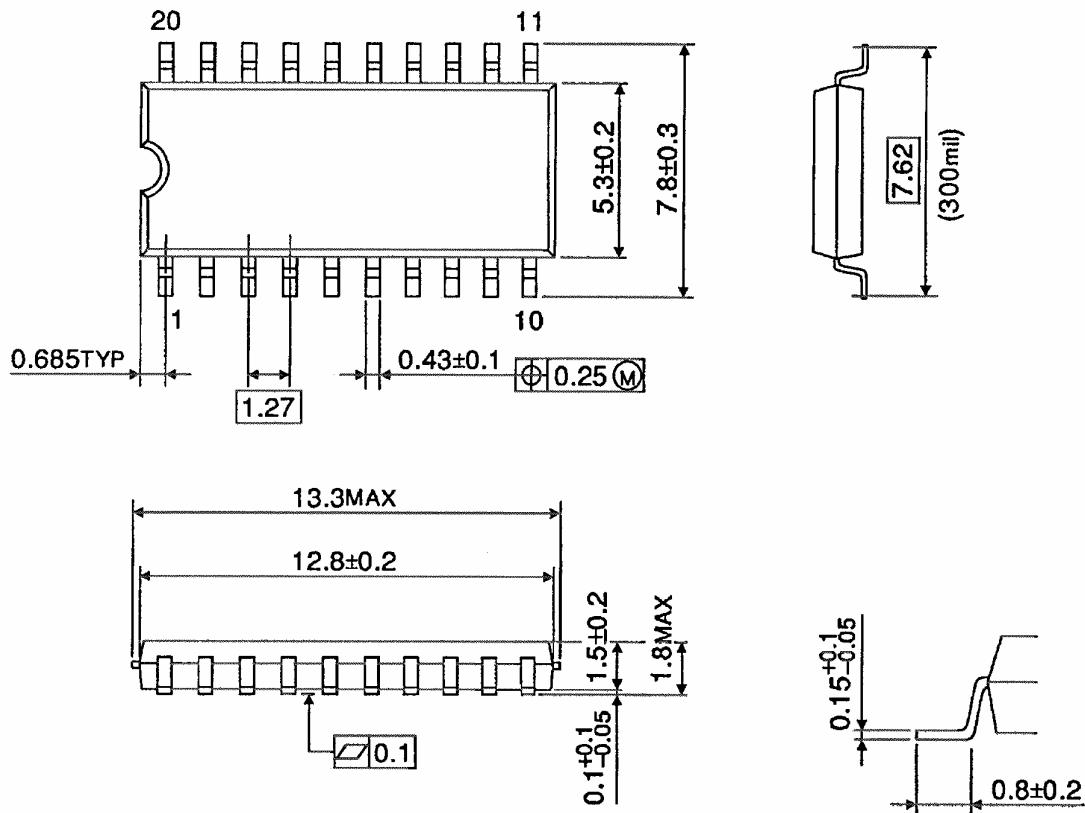


Weight: 0.22 g (typ.)

**Package Dimensions**

SOP20-P-300-1.27

Unit : mm

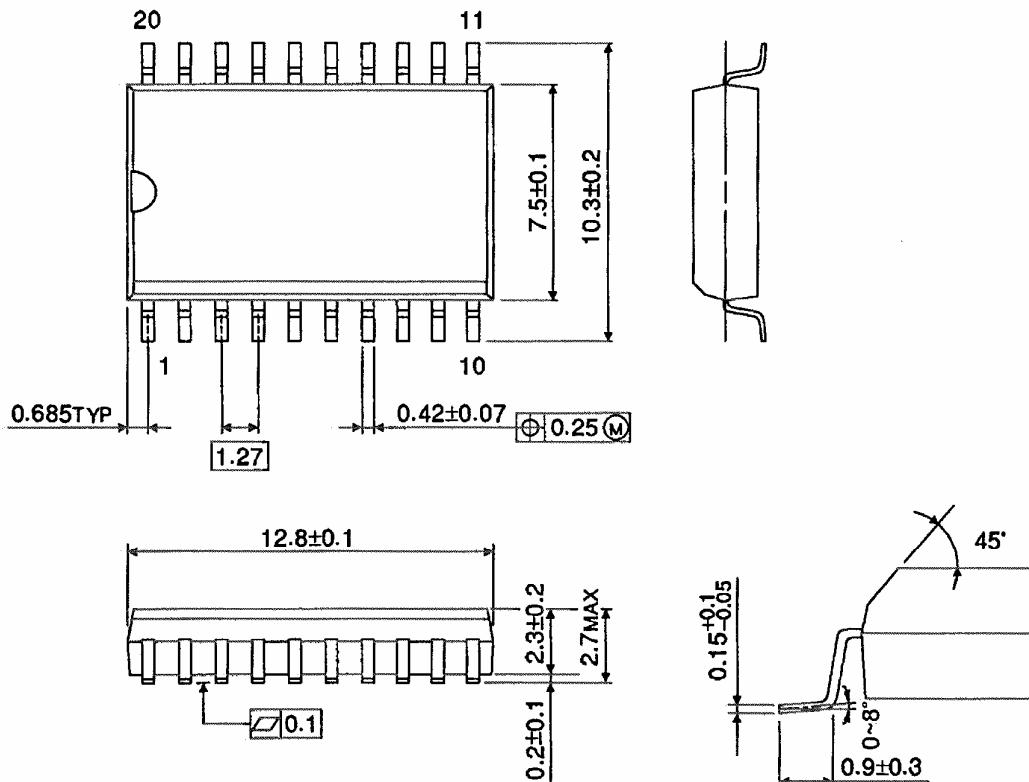


Weight: 0.22 g (typ.)

**Package Dimensions (Note)**

SOL20-P-300-1.27

Unit : mm



Note: This package is not available in Japan.

Weight: 0.46 g (typ.)

**Note: Lead (Pb)-Free Packages****DIP20-P-300-2.54A SOP20-P-300-1.27A****RESTRICTIONS ON PRODUCT USE**

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